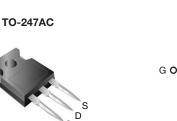
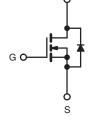


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	500				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.28			
Q _g (Max.) (nC)	130				
Q _{gs} (nC)	33				
Q _{gd} (nC)	59				
Configuration	Single				





N-Channel MOSFET

FEATURES

· SuperFast Body Diode Eliminates the Need For External Diodes in ZVS Applications



RoHS

COMPLIANT

- Low Gate Charge Results in Simple Drive Requirement
- Enhanced dV/dt Capabilities Offer Improved Ruggedness
- Higher Gate Voltage Threshold Offers Improved Noise Immunity
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Zero Voltage Switching SMPS
- Telecom and Server Power Supplies
- Uninterruptible Power Supply
- Motor Control applications

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP17N50LPbF
	SiHFP17N50L-E3
SnPb	IRFP17N50L
	SiHEP17N501

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	500	v	
Gate-Source Voltage			V _{GS}	± 30	v	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	- I _D	16		
		T _C = 100 °C		11	А	
Pulsed Drain Current ^a			I _{DM}	64		
Linear Derating Factor				1.8	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	390	mJ	
Repetitive Avalanche Current ^a			I _{AR}	16	А	
Repetitive Avalanche Energy ^a			E _{AR}	22	mJ	
Maximum Power Dissipation	T _C = 25 °C		P _D	220	W	
Peak Diode Recovery dV/dt ^c			dV/dt	13	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150			
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d	- °C	
Mounting Torque	6-32 or M3 screw			10	lbf · in	
				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Starting T_J = 25 °C, L = 3.0 mH, R_g = 25 Ω , I_{AS} = 16 A (see fig. 12). c. I_{SD} ≤ 16 A, dI/dt ≤ 347 A/µs, V_{DD} ≤ V_{DS}, T_J ≤ 150 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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PARAMETER	SYMBOL	TYP. MAX.			UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 62			°C/W		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50 -					
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.56		-		
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	nless otherw	ise noted)			-		I
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNI
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA ^d	-	0.60	-	V/°(
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		3.0	-	5.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 100	nA
Zana Oata Malta na Duain Ourmant		$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	50	μA
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 400 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	2.0	mA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}$ $I_D = 9.9 \text{ A}^{b}$		-	0.28	0.32	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = 50 \text{ V}, I_D = 9.9 \text{ A}^{b}$		11	-	-	S
Dynamic		•		•			
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5		-	2760	-	
Output Capacitance	Coss			-	325	-	
Reverse Transfer Capacitance	C _{rss}			-	37	-	
			V _{DS} = 1.0 V , f = 1.0 MHz	-	3690	-	- pF
Output Capacitance	C _{oss}		V _{DS} = 400 V , f = 1.0 MHz	-	84	-	
Effective Output Capacitance	C _{oss} eff.	$V_{GS} = 0 V$	V _{DS} = 0 V to 400 V	-	159	-	
Effective Output Capacitance (Energy Related)	C _{oss} eff. (ER)			-	120	-	
Internal Gate Resistance	R _g	f = 1	MHz, open drain	-	1.4	-	Ω
Total Gate Charge	Qg		I _D = 16 A, V _{DS} = 400 V see fig. 7 and 15 ^b	-	-	130	nC
Gate-Source Charge	Q _{qs}	V _{GS} = 10 V		-	-	33	
Gate-Drain Charge	Q _{gd}			-	-	59	
Turn-On Delay Time	t _{d(on)}			-	21	-	1
Rise Time	tr	$V_{DD} = 250 \text{ V}, \text{ I}_D = 16 \text{ A}$		-	51	-	
Turn-Off Delay Time	t _{d(off)}	$R_G = 7.5 \Omega$, $V_{GS} = 10 V$ see fig. 14a and 14b ^b		-	50	-	- ns
Fall Time	t _f			-	28	-	
Drain-Source Body Diode Characteristic	s	•		•			
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	16	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	64	A
Body Diode Voltage	V _{SD}	T _J = 25 °C	C, I _S = 16 A, V _{GS} = 0 V ^b	-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C		-	170	250	
		T _J = 125 °C	I _F = 16 A,	-	220	330	ns
Darthe Diarda Davarra Davarra (Cha	dy Diode Reverse Recovery Charge Q _{rr}	T _J = 25 °C	dl/dt = 100 A/µs ^b	-	470	710	_
Douy Diode Reverse Recovery Charge		T _J = 125 °C		-	810	1210	μC
Reverse Recovery Current	I _{RRM}		T _J = 25 °C	-	7.3	11	
Forward Turn-On Time	t _{on}	Intrincio tu	rn-on time is negligible (tur		ninated h	v L - and	<u> </u>

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 µs; duty cycle ≤ 2 %.
c. C_{OSS} eff. is a fixed capacitance that gives the same charging time as C_{OSS} while V_{DS} is rising fom 0 % to 80 % V_{DS}. C_{OSS} eff. (ER) is a fixed capacitance that stores the same energy as C_{OSS} while V_{DS} is rising fom 0 % to 80 % V_{DS}.

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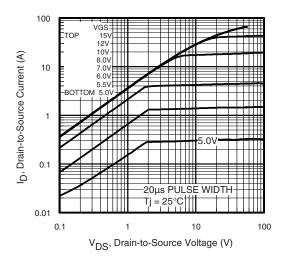


Fig. 1 - Typical Output Characteristics

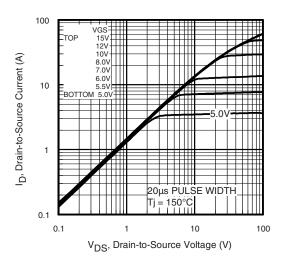


Fig. 2 - Typical Output Characteristics

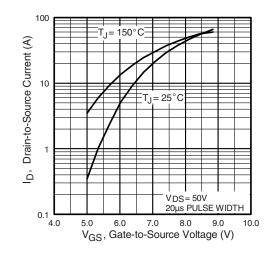


Fig. 3 - Typical Transfer Characteristics

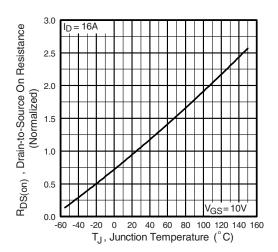


Fig. 4 - Normalized On-Resistance vs. Temperature

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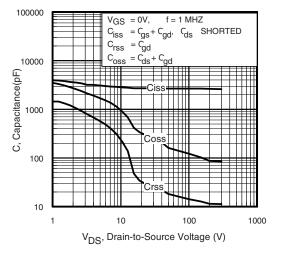
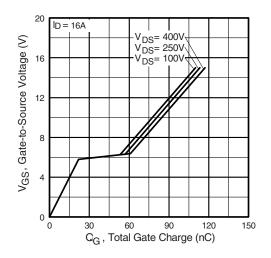


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





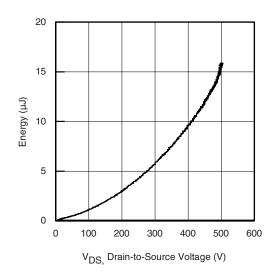


Fig. 6 - Typ. Output Capacitance Stored Energy vs. V_{DS}

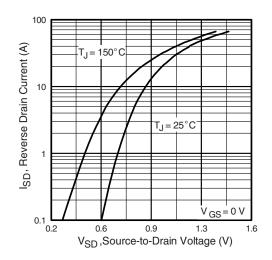


Fig. 8 - Typical Source-Drain Diode Forward Voltage

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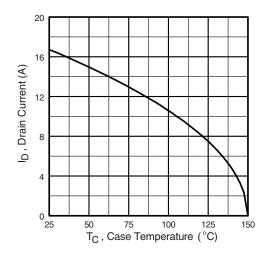


Fig. 9 - Maximum Drain Current vs. Case Temperature

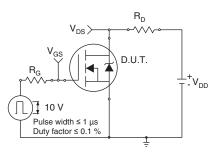


Fig. 10a - Switching Time Test Circuit

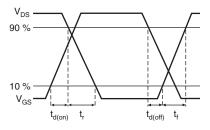


Fig. 10b - Switching Time Waveforms

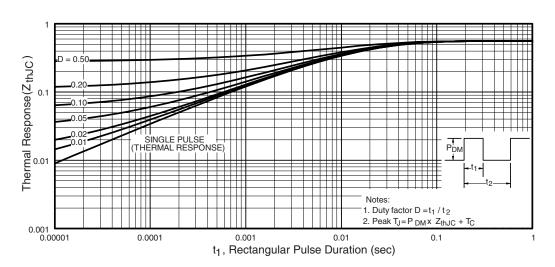


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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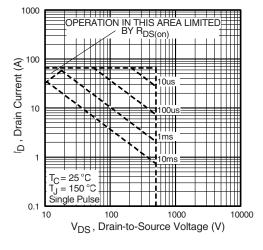


Fig. 12 - Maximum Safe Operating Area

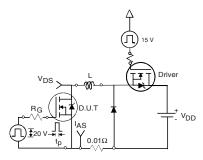


Fig. 14a - Unclamped Inductive Test Circuit

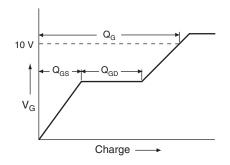


Fig. 15a - Basic Gate Charge Waveform

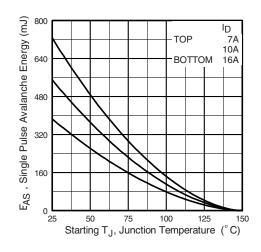


Fig. 13 - Maximum Avalanche Energy vs. Drain Current

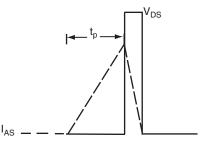
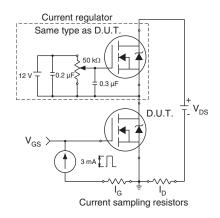


Fig. 14b - Unclamped Inductive Waveforms

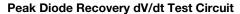


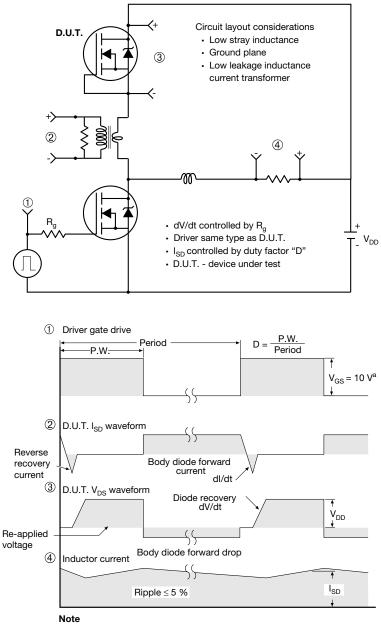


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a. $V_{GS} = 5 V$ for logic level devices

Fig. 16. For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?91205</u>.

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.





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